

PT78NR200 Series

10-12W Plus to Minus Voltage
Integrated Switching Regulator



SLTS074A

(Revised 6/30/2000)

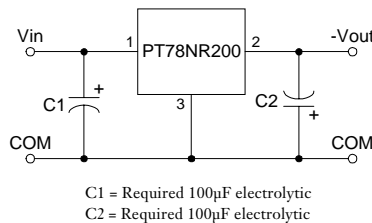
- Negative output from positive input
- Wide Input Range
- Self-Contained Inductor
- Short Circuit Protection
- Over-Temperature Protection
- Fast Transient Response

The PT78NR200 series creates negative output voltage from a posi-

tive input voltage greater than 9V. These easy-to-use, 3-terminal, Integrated Switching Regulators (ISRs) have maximum output power of 10 to 12 watts and a negative output voltage that is laser trimmed. They also have excellent line and load regulation.

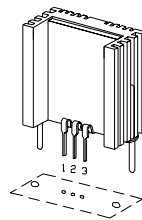
The PT78NR200 requires 100 LFM of airflow at its maximum output current.

Standard Application



Pin-Out Information

| Pin | Function |
|-----|-------------------|
| 1 | +V _{in} |
| 2 | -V _{out} |
| 3 | GND |



SUGGESTED BOARD LAYOUT
COMPONENT SIDE VIEW
Pkg Style 600

Ordering Information

PT78NR2 XX Y

Output Voltage

- 52 = -5.2 Volts
- 06 = -6.0 Volts
- 12 = -12.0 Volts
- 15 = -15.0 Volts

Package Suffix

- H = Horizontal Mount
- S = Surface Mount
- V = Vertical Mount

(For dimensions and PC board layout, see Package Styles 600 and 610.)

Specifications

| Characteristics (T _a = 25°C unless noted) | Symbols | Conditions | PT78NR200 SERIES | | | Units |
|---|------------------------------------|---|---|----------------------|------------|-------------------------|
| | | | Min | Typ | Max | |
| Output Current | I _o | Over V _{in} range | V _o = -5.2V 0.1* V _o = -12.0V 0.1* | — | 2.0 1.0 | A A |
| Short Circuit Current | I _{sc} | V _{in} = 10V | — | 4 × I _{max} | — | A _{pk} |
| Inrush Current | I _{ir} t _{ir} | V _{in} = 10V On start-up | — | 4 0.5 | — | A mSec |
| Input Voltage Range | V _{in} | 0.1 ≤ I _o ≤ I _{max} | 9 | — | 15 | V |
| Output Voltage Tolerance | ΔV _o | Over V _{in} range T _a = 0°C to +70°C | — | ±1.0 | ±3.0 | %V _o |
| Line Regulation | Reg _{line} | Over V _{in} range | — | ±0.5 | ±1.0 | %V _o |
| Load Regulation | Reg _{load} | 0.3 ≤ I _o ≤ I _{max} | — | ±0.5 | ±1.0 | %V _o |
| V _o Ripple/Noise | V _n | V _{in} = 10V, I _o = I _{max} | — | ±2 | — | %V _o |
| Transient Response (with 100µF output cap) | t _{tr} | 50% load change V _o over/undershoot | — | 100 5.0 | 250 | µSec %V _o |
| Efficiency | η | V _{in} = 9V, I _o = 0.5 × I _{max} , V _o = -12V | — | 78 | — | % |
| Switching Frequency | f _o | Over V _{in} and I _o ranges | 600 | 650 | 700 | kHz |
| Absolute Maximum Operating Temperature Range | T _a | 100 LFM airflow Over V _{in} and I _o Ranges | 0 | — | +85 | °C |
| Recommended Operating Temperature Range | T _a | 100 LFM airflow Over V _{in} and I _o Ranges | 0 | — | +60** | °C |
| Thermal Resistance | θ _{ja} | 100 LFM airflow | — | 35 | — | °C/W |
| Storage Temperature | T _s | — | -40 | — | +125 | °C |
| Mechanical Shock | — | Per Mil-STD-883D, Method 2002.3 | — | 500 | — | G's |
| Mechanical Vibration | — | Per Mil-STD-883D, Method 2007.2, 20-2000 Hz, soldered in a PC board | — | 10 | — | G's |
| Weight | — | — | — | 11 | — | Grams |

*ISR will operate down to no load with reduced specifications.

**See Thermal Derating chart.

Note: The PT78NR200 series requires a 100µF electrolytic or tantalum output capacitor for proper operation in all applications.

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| PT78NR206H | ACTIVE | SIP MOD ULE | EFH | 3 | 20 | Pb-Free (RoHS) | Call TI | N / A for Pkg Type |
| PT78NR212H | ACTIVE | SIP MOD ULE | EFH | 3 | 20 | Pb-Free (RoHS) | Call TI | N / A for Pkg Type |
| PT78NR212S | ACTIVE | SIP MOD ULE | EFJ | 3 | 20 | Pb-Free (RoHS) | Call TI | Level-1-215C-UNLIM |
| PT78NR212ST | ACTIVE | SIP MOD ULE | EFJ | 3 | 200 | Pb-Free (RoHS) | Call TI | Level-1-215C-UNLIM |
| PT78NR212V | ACTIVE | SIP MOD ULE | EFF | 3 | 20 | Pb-Free (RoHS) | Call TI | N / A for Pkg Type |
| PT78NR215H | ACTIVE | SIP MOD ULE | EFH | 3 | 20 | Pb-Free (RoHS) | Call TI | N / A for Pkg Type |
| PT78NR215S | ACTIVE | SIP MOD ULE | EFJ | 3 | 20 | Pb-Free (RoHS) | Call TI | Level-1-215C-UNLIM |
| PT78NR215V | ACTIVE | SIP MOD ULE | EFF | 3 | 20 | Pb-Free (RoHS) | Call TI | N / A for Pkg Type |
| PT78NR252H | ACTIVE | SIP MOD ULE | EFH | 3 | 20 | Pb-Free (RoHS) | Call TI | N / A for Pkg Type |
| PT78NR252S | ACTIVE | SIP MOD ULE | EFJ | 3 | 20 | Pb-Free (RoHS) | Call TI | Level-1-215C-UNLIM |
| PT78NR252V | ACTIVE | SIP MOD ULE | EFF | 3 | 20 | Pb-Free (RoHS) | Call TI | N / A for Pkg Type |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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